ABSOLUTE MAXIMUM RATINGS

IN to GND	-0.3V to +30V
SHDN to GND	0.3V to (V _{IN} + 0.3V)
5/3 (MAX8718) to GND	-0.3V to +6V
FB (MAX8719) to GND	0.3V to +6V
OUT (MAX8718) to GND	0.3V to +6V
OUT (MAX8719) to GND	0.3V to +30V
V _{CC} to GND (MAX8718)	0.3V to +6V
V _{CC} to GND (MAX8719)	0.3V to +2.7V
PGOOD to GND	-0.3V to +30V

I.C. to GND	0.3V to +6V
OUT Short Circuit to GND	
Continuous Power Dissipation ($T_A = +70^{\circ}C$)	
8-Pin TDFN (derate 24.4mW/°C above +70°C)	1951mW
Operating Temperature Range40°	C to +85°C
Junction Temperature	+150°C
Storage Temperature Range	C to +150°C
Lead Temperature (soldering, 10s)	+300°C

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

ELECTRICAL CHARACTERISTICS

(Circuit of Figure 1. V_{IN} = 15V, I_{OUT} = 5µA, T_A = 0°C to +85°C. Typical values are at T_A = +25°C, unless otherwise noted.) (Note 1)

PARAMETER	SYMBOL	CONDITIONS	MIN	ТҮР	MAX	UNITS	
Input Voltage Range	VIN		4		28	V	
Supply Current (MAX8718)	lu.	$\overline{\text{SHDN}} = \text{IN}, \text{T}_{\text{A}} = +25^{\circ}\text{C}$		12	18	μs	
	lin	$\overline{\text{SHDN}} = \text{IN}, \text{V}_{\text{IN}} = 6\text{V} \text{ to } 28\text{V}$			25	μΑ	
Version (MAX0710)		$0V < V_{CC} < 2.7V$, $T_A = +25^{\circ}C$	-0.1		+0.1	μA	
V _{CC} Input Current (MAX8719)		$0V < V_{CC} < 2.7V$, $T_A = 0^{\circ}C$ to $+85^{\circ}C$		0.04			
Vee Input Current (MAY0710)		$0V < V_{CC} < 5.5V$, $T_A = +25^{\circ}C$			3.4		
V _{CC} Input Current (MAX8718)		$0V < V_{CC} < 5.5V$, $T_A = 0^{\circ}C$ to $+85^{\circ}C$		2.3		μA	
OUT Minimum Load Current					5	μΑ	
Shutdown Supply Current		$\overline{\text{SHDN}} = 0\text{V}$		1.2	3	μΑ	
Dropout Supply Current		V_{OUT} set to 5V, $V_{IN} = 4.7V$		85		μΑ	
OUT Output Voltage (MAX8718)		$V_{IN} = 6V$ to 28V, $I_{LOAD} = 1mA$, $5\overline{/3} = GND$, $T_A = +25^{\circ}C$	3.26	3.33	3.40	- V	
		$V_{IN} = 6V$ to 28V, $I_{LOAD} = 1mA$, $5\overline{/3} = OUT$, $T_A = +25^{\circ}C$	4.95	5.05	5.15		
		$V_{IN} = 6V$ to 28V, $I_{LOAD} = 5\mu$ A to 100mA, $5\overline{/3} = GND$	3.15		3.48		
		$V_{IN} = 6V$ to 28V, $I_{LOAD} = 5\mu$ A to 100mA, $5\overline{/3} = OUT$	4.75		5.25		
	V _{FB}	FB = OUT, V_{IN} = 6V to 28V, I_{LOAD} = 1mA	1.215	1.240	1.265	V	
FB Threshold (MAX8719)		FB = OUT, V_{IN} = 6V to 28V, I _{LOAD} = 5µA to 100mA (Note 2)	1.18		1.28		
FB Input Current (MAX8719)		$V_{FB} = 1.3V, T_A = +25^{\circ}C$	-30		+30		
	IFB	$V_{FB} = 1.3V$, $T_A = 0^{\circ}C$ to $+85^{\circ}C$		15		nA	
	1= 10	$V_{5/3} = 5V, T_A = +25^{\circ}C$	-30		+30		
5/3 Input Current (MAX8718)	I _{5/3}	$V_{5/3} = 5V$, $T_A = 0^{\circ}C$ to $+85^{\circ}C$		2		nA	
Dropout Voltage	VDROPOUT	I _{LOAD} = 100mA (Note 3)			560	mV	

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ELECTRICAL CHARACTERISTICS (continued)

(Circuit of Figure 1. V_{IN} = 15V, I_{OUT} = 5µA, **T_A = 0°C to +85°C**. Typical values are at T_A = +25°C, unless otherwise noted.) (Note 1)

PARAMETER	SYMBOL	CONDITIONS	MIN	ТҮР	MAX	UNITS
Output Current Limit	I _{LIM}	$V_{IN} = 6V, T_A = +25^{\circ}C$		210		mA
		$V_{OUT} = 0, V_{IN} = 6V$	125		340	
Output Reverse Leakage Current		V_{OUT} forced to 5.5V, IN = unconnected		70		μA
		MAX8718	0.16			
Capacitive Load Requirements		MAX8719	0.23			µF/mA
Startup Time Response		Rising edge of IN or \overline{SHDN} to OUT within spec limits, $C_{OUT} = 10\mu F$, $R_{LOAD} = 500\Omega$, $V_{OUT} = 5V$			1	ms
Startup Output Overshoot		$C_{OUT} = 10\mu$ F, $R_{LOAD} = 500\Omega$, OUT within 90% of the nominal output voltage		0.5		%
V _{CC} Threshold (MAX8718)	18) $T_{A} = +25^{\circ}C, rising edge only$ $0^{\circ}C < T_{A} < +85^{\circ}C, rising edge only$	0.88 × Vout	0.9 × V _{OUT}	0.92 × V _{OUT}		
		$0^{\circ}C < T_{A} < +85^{\circ}C$, rising edge only	0.85 × Vout	0.9 × V _{OUT}	0.95 × V _{OUT}	V
V _{CC} Threshold (MAX8719)		$T_A = +25^{\circ}C$, rising edge only	0.88 × V _{FB}	0.9 × V _{FB}	0.92 × V _{FB}	
		$0^{\circ}C < T_{A} < +85^{\circ}C$, rising edge only	0.85 × V _{FB}	0.9 × V _{FB}	0.95 × V _{FB}	V
V _{CC} to PGOOD Delay		V _{TH} to (V _{TH} - 100mV)		4.5		μs
PGOOD Active-Timeout Period			100	185	300	ms
PGOOD Output Leakage Current		$PGOOD = 5.5V, V_{CC} = 5.5V$			0.1	μA
PGOOD Output Low Voltage		$I_{SINK} = 1.6 \text{mA}, V_{CC} = \text{GND}$			0.3	V
V _{CC} Input Hysteresis				2		%
Thermal-Shutdown Threshold		$V_{\overline{SHDN}} = 0 \text{ or } 15V, 20^{\circ}C \text{ hysteresis}$		+165		°C
SHDN Input Low Voltage					0.25	V
SHDN Input High Voltage			1.4			V
SHDN Input Bias Current		$V_{\overline{SHDN}} = 0 \text{ or } 15V, T_A = 0^{\circ}C \text{ to } +85^{\circ}C$	-1	+0.1	+1	μΑ

ELECTRICAL CHARACTERISTICS

(Circuit of Figure 1 V_{IN} = 15V, I_{OUT} = 5µA, T_A = -40°C to +85°C, unless otherwise noted.) (Note 4)

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS
Input Voltage Range	VIN		4		28	V
Supply Current (MAX8718)	lin	$\overline{\text{SHDN}}$ = IN, V _{IN} = 6V to 28V			25	μΑ
Supply Current (MAX8719)	lin	$\overline{\text{SHDN}}$ = IN, V _{IN} = 6V to 28V			25	μA
OUT Minimum Load Current					5	μΑ
Shutdown Supply Current		$\overline{\text{SHDN}} = 0\text{V}$			3	μΑ
OUT Output Voltage (MAV0710)		$V_{IN} = 6V$ to 28V, $I_{LOAD} = 5\mu$ A to 100mA, $5\overline{/3} = GND$	3.10		3.48	V
OUT Output Voltage (MAX8718)		$V_{IN} = 6V$ to 28V, $I_{LOAD} = 5\mu$ A to 100mA, $5\overline{/3} = OUT$	4.72		5.25	
		$FB = OUT$, $V_{IN} = 6V$ to 28V, $I_{LOAD} = 1mA$	1.215		1.265	
FB Threshold (MAX8719)	V _{FB}	FB = OUT, V_{IN} = 6V to 28V, I _{LOAD} = 5µA to 100mA (Note 2)	1.18		1.28	V
FB Input Current (MAX8719)	I _{FB}	$V_{FB} = 1.3V$	-40		+40	nA
5/3 Input Current (MAX8718)	I _{5/3}	$V_{5/\overline{3}} = 5V$	-30		+30	nA
Dropout Voltage	Vdropout	I _{LOAD} = 100mA (Note 3)			560	mV
Output Current Limit	ILIM	$V_{OUT} = 0$, $V_{IN} = 6V$	125		375	mA
		MAX8718	0.16			μF/mA
Capacitive Load Requirements		MAX8719	0.23			
Startup Time Response		Rising edge of IN or \overline{SHDN} to OUT within spec limits, C _{OUT} = 10µF, R _{LOAD} = 500 Ω , V _{OUT} = 5V			1	ms
V _{CC} Threshold (MAX8718)		$-40^{\circ}C < T_A < +85^{\circ}C$, rising edge only	0.85 × V _{OUT}		0.95 × V _{OUT}	V
V _{CC} Threshold (MAX8719)		$-40^{\circ}\text{C} < \text{T}_{\text{A}} < +85^{\circ}\text{C}$, rising edge only	0.85 × V _{FB}		0.95 × V _{FB}	V
PGOOD Active-Timeout Period			100		300	ms
PGOOD Output Low Voltage		I_{SINK} = 1.6mA, V_{CC} = GND			0.3	V
SHDN Input Low Voltage					0.25	V
SHDN Input High Voltage			1.4			V
SHDN Input Bias Current		$V_{\overline{SHDN}} = 0 \text{ or } 15V, T_A = -40^{\circ}C \text{ to } +85^{\circ}C$	-1		+1	μΑ

Note 1: Limits are 100% production tested at $T_A = +25^{\circ}C$. Limits over the operating temperature range are guaranteed through correlation using standard quality control (SQC) methods.

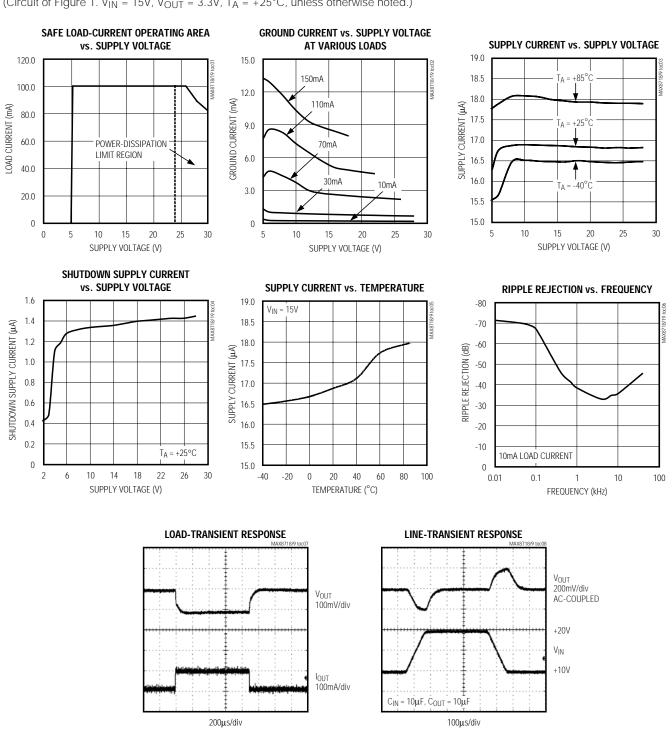
Note 2: Pulse test at $V_{IN} = 28V$, $I_{OUT} = 100$ mA to avoid exceeding package power-dissipation limits.

Note 3: Dropout voltage is tested by reducing the input voltage until V_{OUT} drops to 100mV below its nominal value as measured with VIN starting 2V above VOUT.

Note 4: Specifications to -40°C are guaranteed by design, not production tested.

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MAX8718/MAX871

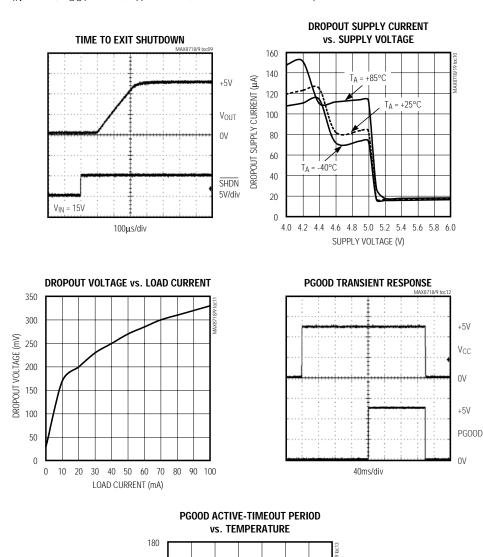


Typical Operating Characteristics

(Circuit of Figure 1. V_{IN} = 15V, V_{OUT} = 3.3V, T_A = +25°C, unless otherwise noted.)

M/X/M

MAX8718/MAX8719



(Circuit of Figure 1. V_{IN} = 15V, V_{OUT} = 3.3V, T_A = +25°C, unless otherwise noted.)

PGOOD ACTIVE-TIMEOUT PERIOD (ms)

175

170

165 160

155

150 -40 -20 0 20 40 60 80 100

TEMPERATURE (°C)

6

Pin Description

PI	IN		FUNCTION		
MAX8718	MAX8719	NAME	FUNCTION		
1	1	IN	Positive Supply Input. Connect to a +4V to +28V supply.		
2	2	GND	Ground		
3	—	5/3	Preset Output-Voltage Select Input. Connect $5/\overline{3}$ to GND for 3.3V output, or to OUT for 5V output.		
_	3	FB	Feedback Input. Regulates to 1.24V nominally.		
4	4	V _C C	PGOOD Sense Input		
5	5	PGOOD	Power-Good Output		
6	6	SHDN	Shutdown Control Input		
7	7	I.C.	Internal Connection. This pin is internally connected for test purposes; leave it unconnected in the application.		
8	8	OUT	100mA Regulator Output		

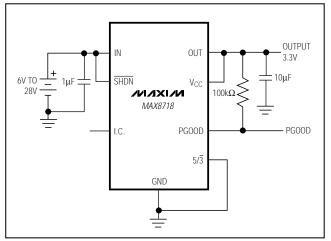


Figure 1. Typical Operating Circuit of the MAX8718

Detailed Description

The MAX8718/MAX8719 low-quiescent-current linear regulators are designed primarily for high-input-voltage applications. The MAX8718 supplies a preselected 3.3V or 5.0V output for loads up to 100mA (Figure 1). The MAX8719 provides an adjustable voltage from 1.24V to 28V (Figure 2). The maximum output current is a function of the package's maximum power dissipation for a given temperature. A 5µA load is required to maintain output regulation.

The MAX8718's output voltage is fed back through an internal resistive voltage-divider connected to OUT. Set the output voltage to either 5.0V or 3.3V with the 5/3

IN OUT OUTPUT Vcc |+ 10µF 6V T SHDN 1uF $100k\Omega$ 28V /M/IXI/M MAX8719 PGOOD PGOOD I.C. R1 FB GND

Figure 2. Typical Operating Circuit of the MAX8719

pin. Select the 5V output by connecting $5/\overline{3}$ to OUT, or the 3.3V output by connecting $5/\overline{3}$ to GND.

The MAX8719's output is adjustable with an external resistive voltage-divider. The typical feedback threshold is 1.24V (see the *Setting the MAX8719 Output Voltage* section). See Figure 3 for the *MAX8718/MAX8719 Functional Diagram.*

Shutdown

The device enters shutdown mode when \overline{SHDN} is low. In shutdown mode, the internal pnp power transistor, control circuit, reference, and all biases turn off, reducing the supply current to below 3µA. Connect \overline{SHDN} to IN for automatic startup.

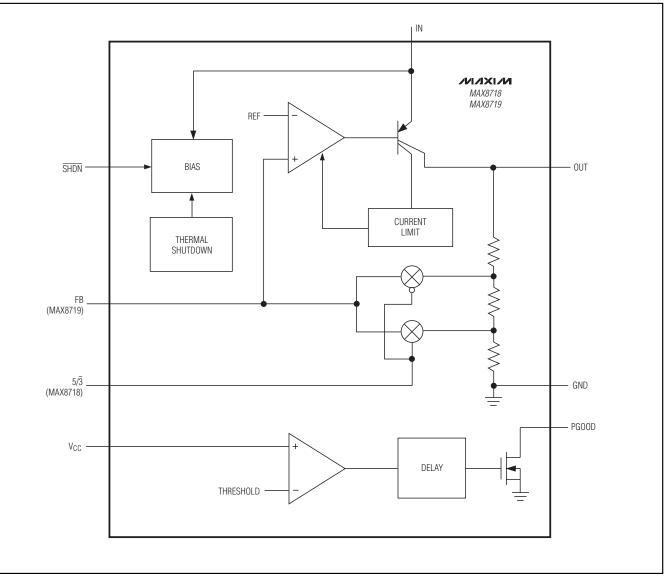


Figure 3. MAX8718/MAX8719 Functional Diagram

Current Limit

Output current is limited to 210mA (typ). The current limit exceeds the 100mA (min) safe operating limit. The output can be shorted to ground for 30 seconds without damaging the part.

Thermal-Overload Protection

When the junction temperature exceeds $T_J = +165^{\circ}C$, an internal thermal sensor sends a signal to the shutdown logic, turning off the pass transistor and allowing the IC to cool. The thermal sensor turns the pass trans-

sistor on again after the IC's junction temperature cools by 20°C (typ), causing the output to pulse on and off during continuous thermal-overload conditions.

Operating Region and Power Dissipation Maximum power dissipation depends on the thermal resistance of the case and circuit board, the temperature difference between the die junction and ambient air, and the rate of airflow. The device's power dissipation is $P = I_{OUT} \times (V_{IN} - V_{OUT})$. The power dissipation at +70°C ambient is 1951mW (see the Absolute Maximum



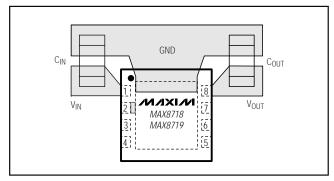


Figure 4. Layout of High-Current Paths

Ratings). The thermal resistance junction-to-case of the TDFN package is 41° C/W, and the maximum safe junction temperature is $+150^{\circ}$ C.

The GND pin and backside pad performs the dual function of providing an electrical connection to ground and channeling heat away from the package. Connect GND and the backside pad to ground using a metal trace or ground plane. The package's overall thermal resistance varies inversely with the copper PC board area attached to the part. To achieve rated thermal resistance, a copper region of at least 650mm² should be attached to the MAX8718/MAX8719s' case.

_Applications Information

Setting the MAX8719's Output Voltage

Set the MAX8719's output voltage with a resistive voltage-divider (R1 and R2 in Figure 3). Choose R2 = $125k\Omega$ or less to maintain a 10μ A minimum load on OUT. Calculate R1 using the following equation:

$$R1 = R2 \times \left(\frac{V_{OUT}}{V_{FB}} - 1\right)$$

where $V_{FB} = 1.24V$ (typ).

Capacitor Selection

Use a $0.1\mu F$ (min) capacitor on the input. Higher values improve the line-transient response.

Use a 1µF (min) capacitor on the output, or a 15µF capacitor for the full 100mA load current. Otherwise, use a 1µF plus 0.16µF/mA (0.23µF/mA for the MAX8719). For output voltages less than 3.3V, use 15µF instead of 10µF. The output capacitor's equivalent series resistance (ESR) must be less than 1 Ω for stable operation.

Output-Voltage Noise

The MAX8718/MAX8719 typically exhibit 5mV_{P-P} of noise during normal operation. This is negligible in

most applications. In applications that include analogto-digital converters (ADCs) of more than 12 bits, consider the ADC's power-supply rejection specifications.

Transient Response

The *Typical Operating Characteristics* show the MAX8718/MAX8719s' load-transient response. When a step-in load current is applied, there are two components to the regulator's response. There is an instantaneous step in the output voltage due to the output capacitor's ESR and the regulator's finite output impedance. The second, slower component is the regulator's active correction to the output voltage. Typical step changes in the OUT load current from 10mA to 20mA produce 20mV transients.

Power-Good Output (PGOOD)

The MAX8718/MAX8719 include an independent power-good monitor. This circuit has an uncommitted sense input (V_{CC}) that can be connected to the regulator's output or similar voltage. In the MAX8718, the comparator threshold tracks the output set point according to the state of 5/3. In the MAX8719, the comparator threshold is set to the feedback reference voltage. The PGOOD output goes high when V_{CC} is greater than -10% of the regulation set point. There is a fixed 100ms (min) delay when the output goes into regulation, which helps ensure proper output-voltage settling. The PGOOD delay when transitioning out of regulation is much faster, 4.5 μ s (typ), which permits the system to respond as fast as possible to the out-of-regulation condition.

The power-good monitor has an open-drain output, which can be externally pulled up to OUT. The voltage rating for PGOOD is 28V.

Layout Guidelines

Good layout is important to minimize the effects of noise and ensure accurate voltage regulation. Use appropriate trace widths for the high-current paths and keep traces short to minimize parasitic inductance and capacitance. Figure 4 shows a layout of the high-current paths. Place bypass capacitors close to the IN and OUT pins. When using the MAX8719, the feedback resistors should be placed close to the device to avoid voltage drops on ground that may shift the output voltage. Connect the exposed backside paddle to as large a copper area as practical.

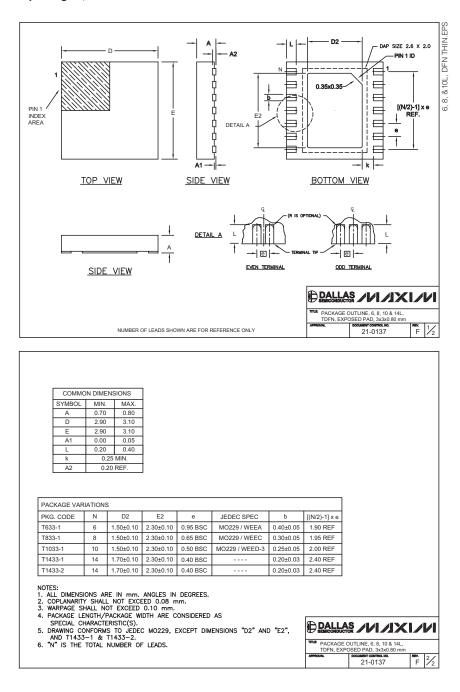
_Chip Information

TRANSISTOR COUNT: 1298 PROCESS: BICMOS



Package Information

(The package drawing(s) in this data sheet may not reflect the most current specifications. For the latest package outline information, go to **www.maxim-ic.com/packages**.)



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